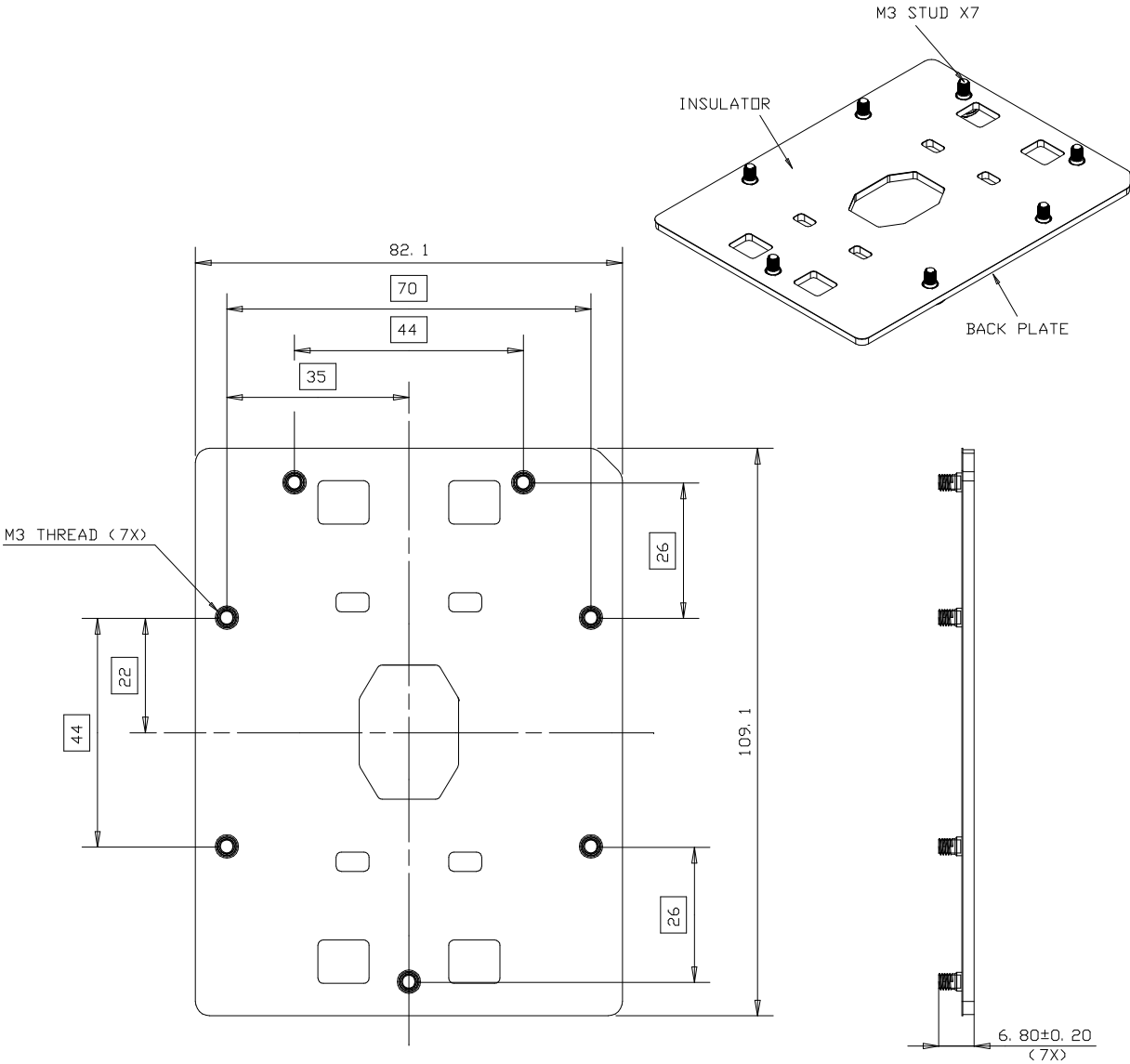
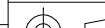


REV.	ECN. NO.	APPD.
A	BC-16-0017036	S. Szu
B	BC-16-0037492	Nick Lin

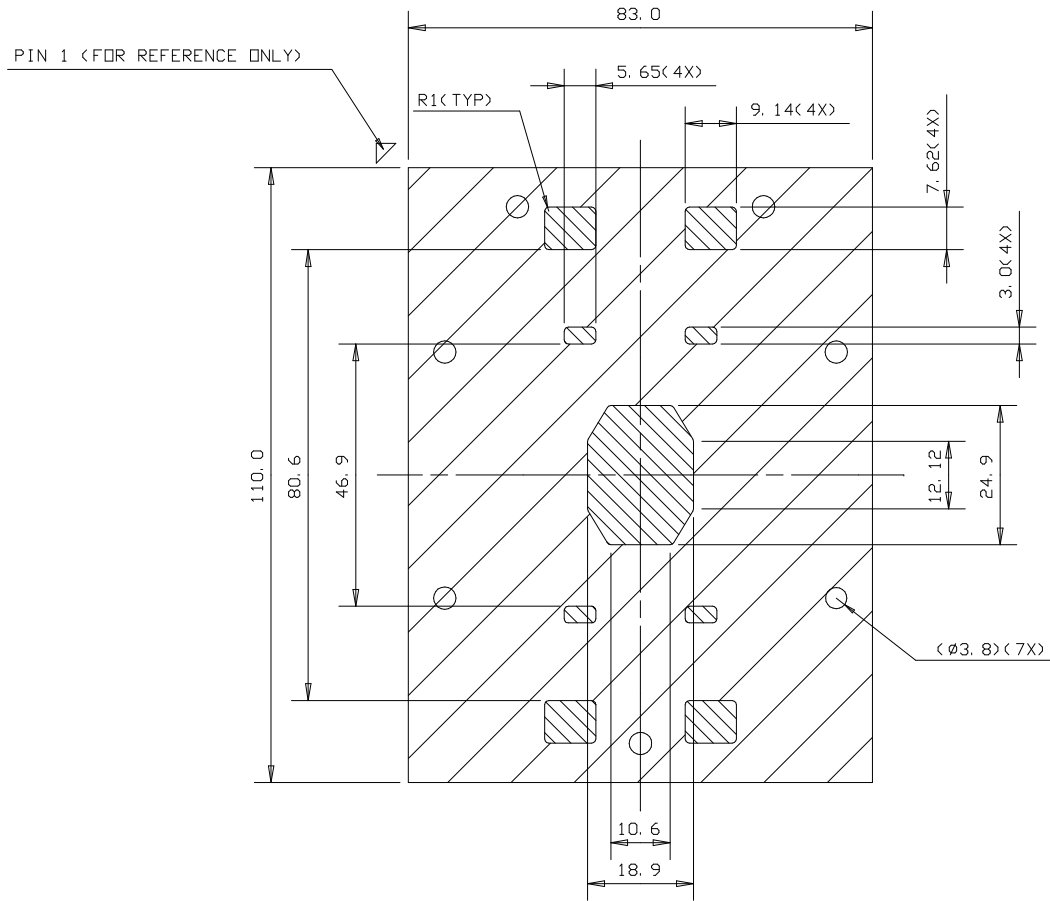
- NOTES:
- ALL DIMENSIONS ARE IN MILLIMETERS.
 - DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
 - DATE CODE & FOXCONN LOGO POSITION APPROXIMATELY, LARGER MARK
 - MATERIAL:
 - BACK PLATE: CARBON STEEL W/ NI PLATING OVERALL
 - STUD: CARBON STEEL W/ NI PLATING OVERALL
 - INSULATOR: PLASTIC PC
 - HARMFUL MATERIAL CONTROL PLEASE FOLLOW DDC. NO. "EP112".
 - THE CONCENTRATIONS OF Br AND Cl CAN SATISFY THE REQUIREMENT OF HALOGEN-FREE IN THE DOCUMENT "EP112".
 - PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY PRODUCT DETAIL AND AVAILABILITY.



X. ±	X. ° ± 1°	UNITS mm	NAME(INTENDED USE)	FOXCONN®		
. X ± 0. 30	. X ° ±	MAT' L	SKX-EP BACK PLATE	FOXCONN INTERCONNECT TECHNOLOGY LIMITED.		
. XX ± 0. 13	. XX ° ±		PART NO. (INTENDED USE)	CLASS:		
. XXX ±	. XXX ° ±		PT44P11-4801	☐ CONFIDENTIAL ☐ SECRET ☒ GENERAL		
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED AND SHALL NOT BE REPRODUCED COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED.			APPD: Nick Lin	TITLE: SKX-EP NARROW BACK PLATE		
		CHKD: Dickie Huang Mac Peng	DWG NO. :			
		DR: Garnett Wu 9/12' 16	351-0000-1386			
		Q' TY				
				SCALE	SHEET	REV.
				1: 1	1/2	B

PT44P11-4801	SKX-EP BACK PLATE
PART NUMBER	DESCRIPTION

REV.	ECN.	NO.	APPD.



RECOMMENDED PCB LAYOUT (VIEWED FROM PCB SECONDARY SIDE)

KOZ LEGEND	
	BACK PLATE ZONE, NO OTHER COMPONENT PLACEMENT ALLOWED, 0.0 MM HEIGHT RESTRICTION
	SECONDARY SIDE SOCKET CAVITY AND COMPONENT ZONES, 1.8 MM MAX COMPONENT HEIGHT

X. ±	X. ° ± 1°	UNITS mm	NAME (INTENDED USE)	FOXCONN®			
. X ± 0.25	. X ° ±	MAT'L	SKX-EP BACK PLATE	FOXCONN INTERCONNECT TECHNOLOGY LIMITED.			
. XX ± 0.13	. XX ° ±	FINISH	PART NO. (INTENDED USE)	CLASS: ☐ CONFIDENTIAL ☐ SECRET ☒ GENERAL			
. XXX ±	. XXX ° ±		PT44P11-4801	TITLE: SKX-EP NARROW BACK PLATE			
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED AND SHALL NOT BE REPRODUCED COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED.			APPD: Nick Lin	DWG NO. :			
			CHKD: Dickie Huang Mac Peng	351-0000-1386			
			DR: Garnett Wu 9/12/16	 SCALE SHEET REV. 1: 1 2/2 B			

